

Manual Update Sheet

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Document Being Updated: *TMS320C2x User's Guide*

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This Manual Update Sheet appends TMS320C25FNA specifications to the TMS320C25/TMS320E25 Digital Signal Processors Data Sheet (Appendix A) in the *TMS320C2x User's Guide*.

Page: **Change or Add:**

A–19 In Appendix A, under electrical characteristics over specified free air temperature range, the TMS320C25GBA and the TMS320C25FNA specs are included in the following table for the input current on the X2/CLKIN pin.

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
I _I	All inputs except X2/CLKIN	V _I = V _{SS} to V _{CC}	– 10	10	μA
	X2/CLKIN	V _I = V _{SS} to V _{CC}	– 20	20	μA

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